

DATA SHEET

GENERAL PURPOSE CHIP RESISTORS

RC0402 (Pb Free)

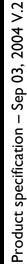
5%, 1%







YAGEO







Chip Resistor Surface Mount

c. l

SERIES

0402 (Pb Free)

SCOPE

This specification describes RC0402 series chip resistors with lead-free terminations made by thick film process.

ORDERING INFORMATION

Part number is identified by the series, size, tolerance, packing type, temperature coefficient, taping reel and resistance value.

YAGEO ORDERING CODE

CTC CODE

RC0402 X X X XX XXXX L

(1) (2) (3) (4) (5)

(I) TOLERANCE

 $F = \pm 1\%$

 $| = \pm 5\%$

(2) PACKAGING TYPE

R = Paper/PE taping reel

(3) TEMPERATURE COEFFICIENT OF RESISTANCE

- = Base on spec

(4) TAPING REEL

07 = 7 inch dia, Reel

10 = 10 inch dia. Reel (not preferred)

13 = 13 inch dia. Reel

(5) RESISTANCE VALUE

5R6, 56R, 560R, 56K, 10M.

(6) RESISTOR TERMINATIONS

L = Lead free terminations (pure Tin)

ORDERING EXAMPLE

The ordering code of a RC0402 chip resistor, value 56 Ω with ±1% tolerance, supplied in 7-inch tape reel is: RC0402FR-0756RL.

NOTE

- I. The "L" at the end of the code is only for ordering. On the reel label, the standard CTC will be mentioned an additional stamp "LFP"= lead free production.
- 2. Products with lead in terminations fulfil the same requirements as mentioned in this datasheet.
- 3. Products with lead in terminations will be phased out in the coming months (before July 1st, 2006)





Chip Resistor Surface Mount RC SERIES

MARKING

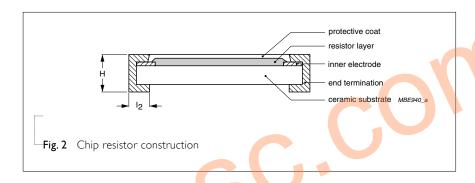
RC0402



No marking

CONSTRUCTION

The resistors are constructed out of a high-grade ceramic body. Internal metal electrodes are added at each end and connected by a resistive paste. The composition of the paste is adjusted to give the approximate required resistance and laser cutting of this resistive layer that achieves tolerance trims the value. The resistive layer is covered with a protective coat.



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Finally, the two external terminations (pure Tin) are added. See fig. 2.

DIMENSIONS

Table I	
TYPE	RC0402
L (mm)	1.00 ±0.05
W (mm)	0.50 ±0.05
H (mm)	0.35 ±0.05
Iı (mm)	0.20 ±0.10
l ₂ (mm)	0.25 ±0.10

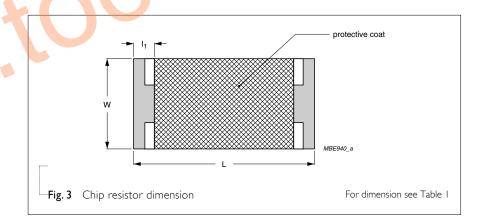




Table 2

Chin Resistor Surface Mount RC SERIES 0402 (Pb Free)

ELECTRICAL CHARACTERISTICS

CHARACTERISTICS	R	.C0402 I/I6 W
Operating Temperature Range	-55	5 °C to +155 °C
Maximum Working Voltage		50 V
Maximum Overload Voltage		100 V
Dielectric Withstanding Voltage		100 V
	5% (E24)	Ι Ω to 10 ΜΩ
Resistance Range	1% (E96)	I Ω to I0 M Ω
	Zero Ohm J	umper < 0.05 Ω
Temperature Coefficient	$10 \Omega < R \le 10 M\Omega$	±100 ppm/°C
	$I \Omega < R \le I0 \Omega$	±200 ppm/°C
Jumper Criteria	Rated Current	1.0 A
Juliipei Criteria	N4 1 0	20.4

<u>FOOTPRINT AND SOLDERING</u> PROFILES

For recommended footprint and soldering profiles, please see the special data sheet "Chip resistors mounting".

ENVIRONMENTAL DATA

For material declaration information (IMDS-data) of the products, please see the separated info "Environmental data".

PACKING STYLE AND PACKAGING QUANTITY

Table 3 Packing style and packaging quantity

PRODUCT TYPE	PACKING STYLE	REEL DIMENSION	QUANTITY PER REEL
RC0402	Paper / PE Taping Reel (R)	7" (178 mm)	10,000 units
		IO" (254 mm) / not preferred	20,000 units
	37 ()	13" (330 mm)	50,000 units

2.0 A

NOTE

1. For Paper/PE tape and reel specification/dimensions, please see the special data sheet "Packing" document.

Maximum Current



SERIES

FUNCTIONAL DESCRIPTION

POWER RATING

RC0402 rated power at 70°C is I/I6 W

RATED VOLTAGE

The DC or AC (rms) continuous working voltage corresponding to the rated power is determined by the following formula:

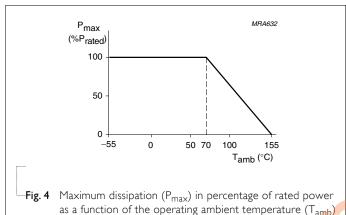
$$V=\sqrt{(P \times R)}$$

Where

V=Continuous rated DC or AC (rms) working voltage (V)

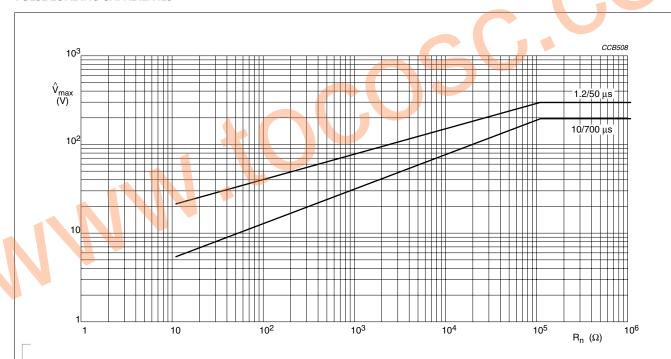
P=Rated power (W)

R=Resistance value (Ω)



as a function of the operating ambient temperature (T_{amb})

PULSE LOADING CAPABILITIES



Maximum permissible peak pulse voltage without failing to open circuit' in accordance with DIN IEC 60040 (CO) 533 for type: RC0402



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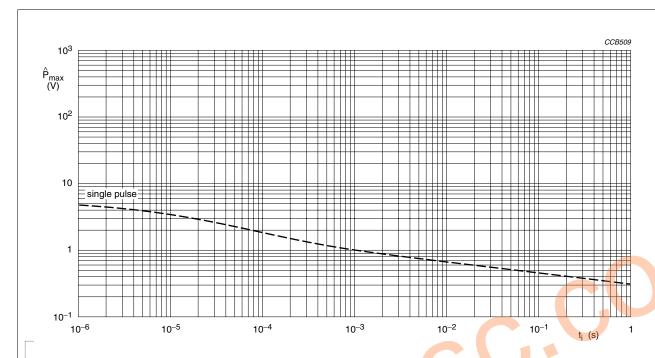


Fig. 6 Pulse on a regular basis for type: RC0402; maximum permissible peak pulse power as a function of pulse duration for single pulse and repetitive pulse tp/ti = 1000

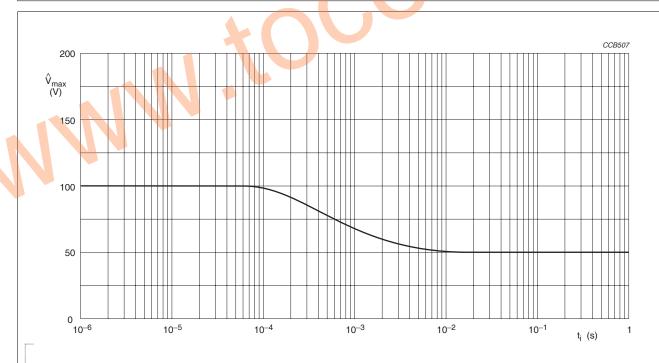


Fig. 7 Pulse on a regular basis for type: RC0402; maximum permissible peak pulse voltage as a function of pulse duration



TESTS AND REQUIREMENTS

Table 4 Test condition, procedure and requirements

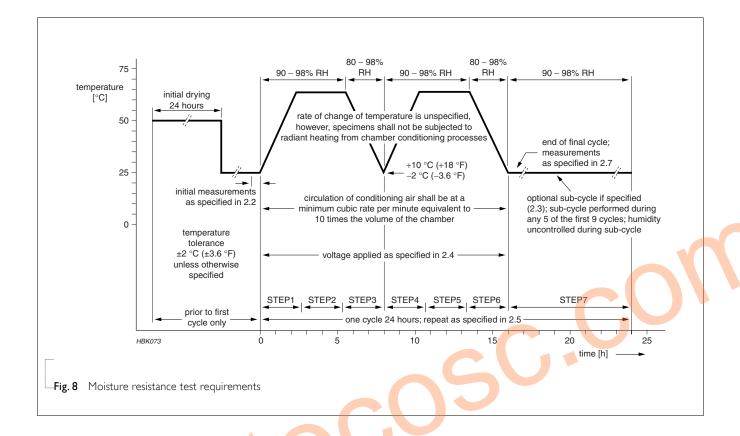
TEST	TEST METHOD	PROCEDURE	REQUIREMENTS
Temperature Coefficient of	MIL-STD-202F-method 304; JIS C 5202-4.8	At +25/–55 °C and +25/+125 °C	Refer to table 2
Resistance (T.C.R.)		Formula: T.C.R= $\frac{R_2-R_1}{R_1(t_2-t_1)} \times 10^6 \text{ (ppm/°C)}$	
		Where t_1 =+25 °C or specified room temperature	
		t_2 =–55 °C or +125 °C test temperature	
		R _I =resistance at reference temperature in ohms	
		R ₂ =resistance at test temperature in ohms	
Thermal Shock	MIL-STD-202F-method 107G;	At -65 (+0/-10) °C for 2 minutes and at +155	$\pm (0.5\% + 0.05 \ \Omega)$ for 1% tol.
	IEC 60115-1 4.19	(+10/-0) °C for 2 minutes; 25 cycles	$\pm (1.0\% \pm 0.05 \ \Omega)$ for 5% tol.
Low	MIL-R-55342D-Para 4.7.4	At -65 (+0/-5) °C for I hour; RCWV applied	\pm (0.5%+0.05 Ω) for 1% tol.
Temperature		for 45 (+5/–0) minutes	$\pm (1.0\% + 0.05 \ \Omega)$ for 5% tol.
Operation		-CU	No visible damage
Short Time	MIL-R-55342D-Para 4.7.5;	2.5 × RCWV applied for 5 seconds at room	$\pm (1.0\% + 0.05 \ \Omega)$ for 1% tol.
Overload	IEC 60115-1 4.13	tempe <mark>ra</mark> ture	$\pm (2.0\% + 0.05~\Omega)$ for 5% tol.
	- 11		No visible damage
Insulation	MIL-STD-202F-method 302;	RCOV for 1 minute	≥10 GΩ
Resistance	IEC 60115-1 4.6.1.1	Type RC0402	
Na.		Voltage (DC) 100 V	
Dielectric	MIL-STD-202F-method 301;	Maximum voltage (V _{ms}) applied for 1 minute	No breakdown or flashover
Withstand Voltage	IEC 60115-1 4.6.1.1	Type RC0402	
Voltage		Voltage (AC) 100 V _{rms}	
Resistance to	MIL-STD-202F-method 210C;	Unmounted chips; 260 ±5 °C for 10 ±1	$\pm (0.5\% \pm 0.05~\Omega)$ for 1% tol.
Soldering	IEC 60115-1 4.18	seconds	\pm (1.0%+0.05 Ω) for 5% tol.
Heat			No visible damage
Life	MIL-STD-202F-method 108A; IEC 60115-1 4.25.1	At 70±2 °C for 1,000 hours; RCWV applied for 1.5 hours on and 0.5 hour off	\pm (1%+0.05 Ω) for 1% tol. \pm (3%+0.05 Ω) for 5% tol.



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TEST	TEST METHOD	PROCEDURE	REQUIREMENTS
Solderability	MIL-STD-202F-method 208A;	Solder bath at 245±3 °C	Well tinned (≥95% covered)
	IEC 60115-1 4.17	Dipping time: 2±0.5 seconds	No visible damage
Bending Strength	JIS C 5202.6.14; IEC 60115-1 4.15	Resistors mounted on a 90 mm glass epoxy resin PCB (FR4) Bending: 5 mm	\pm (1.0%+0.05 Ω) for 1% tol. \pm (1.0%+0.05 Ω) for 5% tol. No visible damage
Resistance to Solvent	MIL-STD-202F-method 215; IEC 60115-1 4.29	Isopropylalcohol (C_3H_7OH) or dichloromethane (CH_2Cl_2) followed by brushing	No smeared
Noise	JIS ⊂ 5202 5.9;	Maximum voltage (V _{rms}) applied.	Resistors range Value
	IEC 60115-1 4.12	_cosc	$\begin{array}{c cccc} R < 100 \ \Omega & 10 \ dB \\ \hline 100 \ \Omega \leq R < 1 \ K\Omega & 20 \ dB \\ \hline 1 \ K\Omega \leq R < 10 \ K\Omega & 30 \ dB \\ \hline 10 \ K\Omega \leq R < 100 \ K\Omega & 40 \ dB \\ \hline 100 \ K\Omega \leq R < 1 \ M\Omega & 46 \ dB \\ \hline 1 \ M\Omega \leq R \leq 22 \ M\Omega & 48 \ dB \\ \hline \end{array}$
Humidity (steady state)	JIS C 5202 7.5; IEC 60115-8 4.24.8	I,000 hours; 40±2 °C; 93(+2/-3)% RH RCWV applied for I.5 hours on and 0.5 hour off	$\pm (0.5\% + 0.05 \ \Omega)$ for 1% tol. $\pm (2.0\% + 0.05 \ \Omega)$ for 5% tol.
Leaching	EIA/IS 4.13B; IEC 60115-8 4.18	Solder bath at 260±5 °C Dipping time: 30±1 seconds	No visible damage
Intermittent Overload	JIS C 5202 5.8	At room temperature; 2.5 × RCWV applied for I second on and 25 seconds off; total 10,000 cycles	$\pm (1.0\% + 0.05~\Omega)$ for 1% tol. $\pm (2.0\% + 0.05~\Omega)$ for 5% tol.
Resistance to Vibration	On request	On request	
Moisture Resistance Heat	MIL-STD-202F-method 106F; IEC 60115-1 4.24.2	42 cycles; total 1,000 hours Shown as Fig. 8	$\pm (0.5\% + 0.05\Omega)$ for 1% tol. $\pm (2.0\% + 0.05\Omega)$ for 5% tol. No visible damage

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REVISION HISTORY

REVISION	DATE	CHANGE NOTIFICATION	DESCRIPTION
Version 2	Sep 03, 2004	-	- Test method and procedure updated
			- PE tape added (paper tape will be replaced by PE tape)

